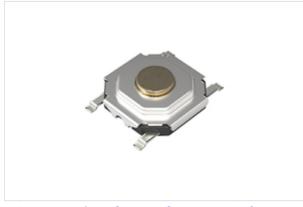


Surface Mount Type TACT Switch™ > SKQG Series > SKQGAFE010

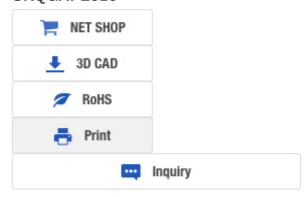
5.2mm Square Low-profile Type (Surface Mount) SKQG Series

| <u>Dimensions</u> | <u>ランド寸法図</u> | <u>Circuit Diagram</u> | <u>Packing Specifications</u> |

| Soldering Conditions |



Part number <u>Series Common Info</u> **SKQGAFE010**



With stem

Type Surface mount

Operating force 0.98N

Operating direction Top push

Travel 0.25mm

Operating life

500,000 cycles

(5mA 5V DC)

Initial contact resistance $100m\Omega$ max.

Sharp feeling type Series type

Operating temperature

range

-40°C to +90°C

Rating (max.) 50mA 12V DC

Rating (min.) 10μA 1V DC

Insulation

 $100M\Omega$ min. 100V DC for 1min.

Electrical

resistance

performance Voltage

proof

250V AC for 1 min.

10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the

frequencies, in the 3 direction of X, Y and Z for 2 hours Durability Vibration

respectively

 -30 ± 2 °C for 96h Cold

Environmental Dry heat 80 ± 2 °C for 96h

performance

Damp

 60 ± 2 °C, 90 to 95%RH for 96h

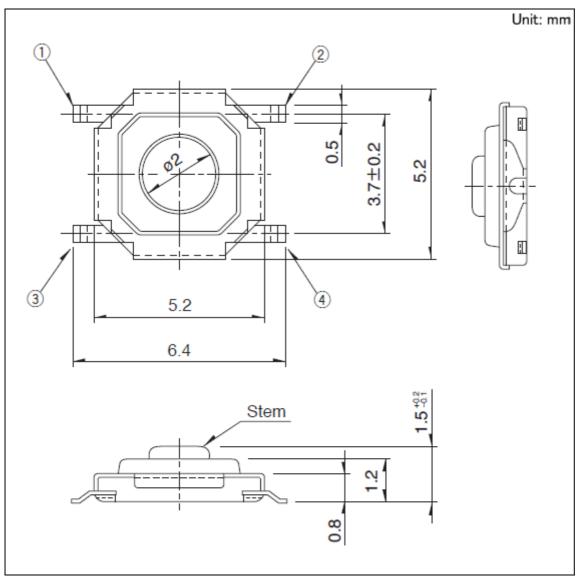
heat

Japan 4,000

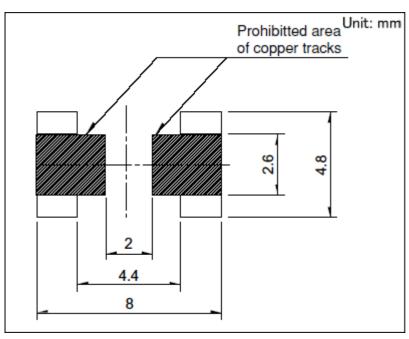
Minimum order unit (pcs.)

Export 4,000

Dimensions

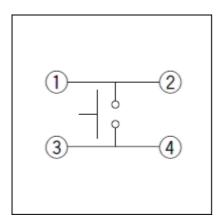


ランド寸法図



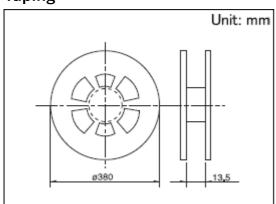
Viewed from mounting face.

Circuit Diagram



Packing Specifications

Taping



	1 reel	4,000
Number of	1 case / Japan	40,000
packages (pcs.)	1 case / export packing	40,000
Tape width (mm)		12

Export package measurements (mm) 395 × 395 × 205

Soldering Conditions

Condition for Reflow

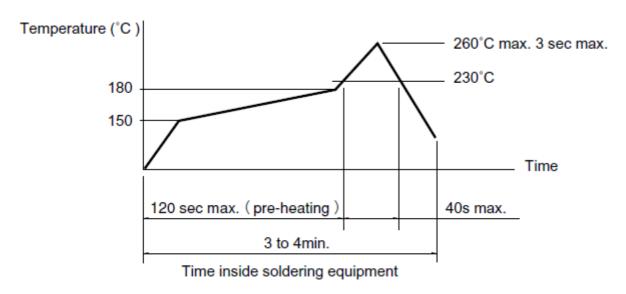
1. Heating method

Double heating method with infrared heater.

2. Temperature measurement

Thermocouple 0.1 to 0.2 Φ CA(K) or CC(T) at solder joints (copper foil surface). A heat resisting tape should be used for fix measurement.

3. Temperature profile



- (1) The above temperature shall be measured of the top of switch. There are cases where PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC board's and others. Care, should be taken to prevent the switch's surface temperature from exceeding 260°C.
- (2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Manual Soldering

Items Condition
Soldering temperature 350°C max.
Duration of soldering 3s max.
Capacity of soldering iron 60W max.

- 1. Do not washing the TACT Switch™.
- 2. Prevent flux penetration from the top side of the TACT switch™.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch returns to normal temperature.

Notes are common to this series/models.

1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.

- 2. For ϕ 330mm diameter reel requirements, please contact us.
- 3. This products can be used in vehicles.

 Although these products are designed to perform over a wide operating temperature range, please ensure that you receive and read the formal delivery specifications before use.

Inquiries about Products

<u>Inquiry</u>

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